

MBRA340T3

Surface Mount Schottky Power Rectifier SMA Power Surface Mount Package

Employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State of the art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bent Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Guardring for Stress Protection
- Pb-Free Package is Available

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm tape, 5000 units per 13 inch reel
- Polarity: Cathode Lead Indicated by Polarity Band
- ESD Ratings: Machine Model = C
Human Body Model = 3B
- Device Meets MSL 1 Requirements

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|---------------------------------|-------------|------------------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V_{RRM} V_{RWM} V_R | 40 | V |
| Average Rectified Forward Current (At Rated V_R , $T_L = 100^\circ\text{C}$) | I_O | 3.0 | A |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | I_{FSM} | 100 | A |
| Storage/Operating Case Temperature | T_{stg} , T_C | -55 to +150 | °C |
| Operating Junction Temperature | T_J | -55 to +125 | °C |
| Voltage Rate of Change (Rated V_R , $T_J = 25^\circ\text{C}$) | dv/dt | 10,000 | V/ μs |

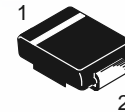
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



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**SCHOTTKY BARRIER
RECTIFIER
3.0 AMPERES
40 VOLTS**



**SMA
CASE 403D
PLASTIC**

MARKING DIAGRAM

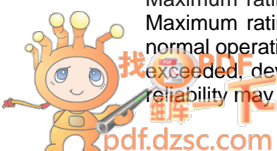


A34 = Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week

ORDERING INFORMATION

| Device | Package | Shipping† |
|------------|------------------|------------------|
| MBRA340T3 | SMA | 5000/Tape & Reel |
| MBRA340T3G | SMA (Pb-Free) | 5000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.



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THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------|---------------|
| Thermal Resistance – Junction-to-Lead (Note 1) | $R_{\theta JL}$ | 15 | $^{\circ}C/W$ |
| Thermal Resistance – Junction-to-Ambient (Note 1) | $R_{\theta JA}$ | 81 | $^{\circ}C/W$ |

ELECTRICAL CHARACTERISTICS

| | | | | |
|---|-------|---------------------|----------------------|-------|
| Maximum Instantaneous Forward Voltage (Note 2) $(I_F = 3.0 \text{ A})$ | V_F | $T_J = 25^{\circ}C$ | $T_J = 100^{\circ}C$ | Volts |
| | | 0.450 | 0.390 | |
| Maximum Instantaneous Reverse Current $(V_R = 40 \text{ V})$ | I_R | $T_J = 25^{\circ}C$ | $T_J = 100^{\circ}C$ | mA |
| | | 0.3 | 15 | |

1. Mounted on 2" Square PC Board with 1" Square Total Pad Size, PC Board FR4.
2. Pulse Test: Pulse Width $\leq 250 \mu s$, Duty Cycle $\leq 2.0\%$.

TYPICAL CHARACTERISTICS

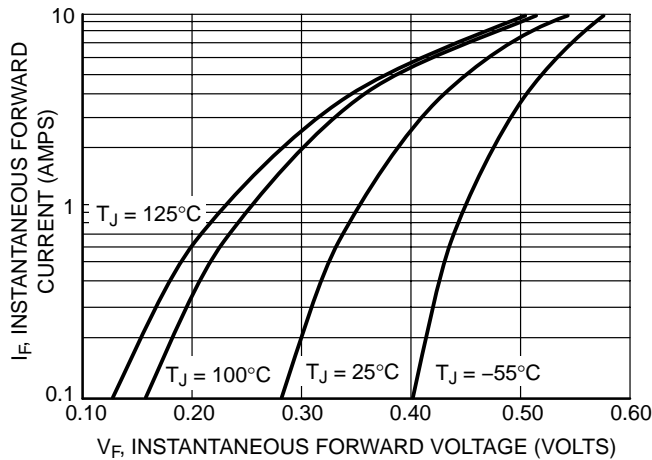


Figure 1. Typical Forward Voltage

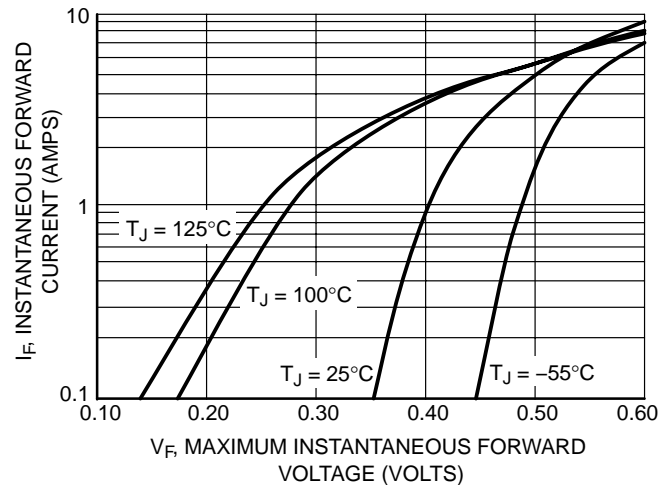


Figure 2. Maximum Forward Voltage

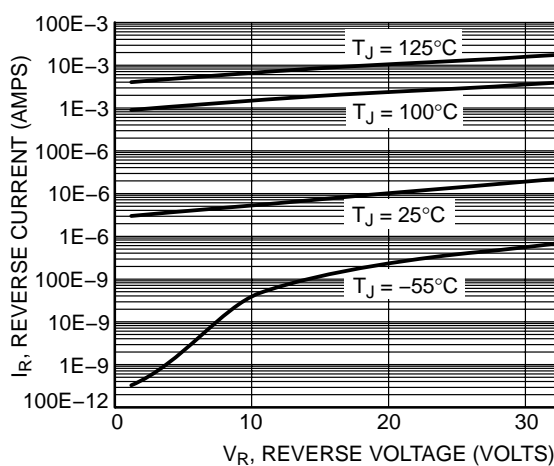


Figure 3. Typical Reverse Current

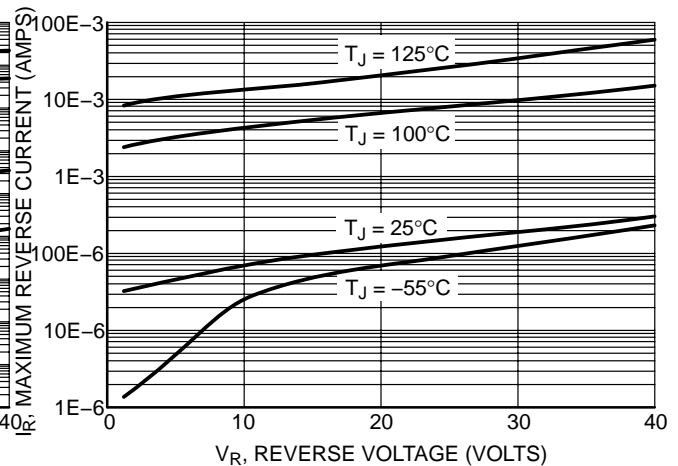


Figure 4. Maximum Reverse Current

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TYPICAL CHARACTERISTICS

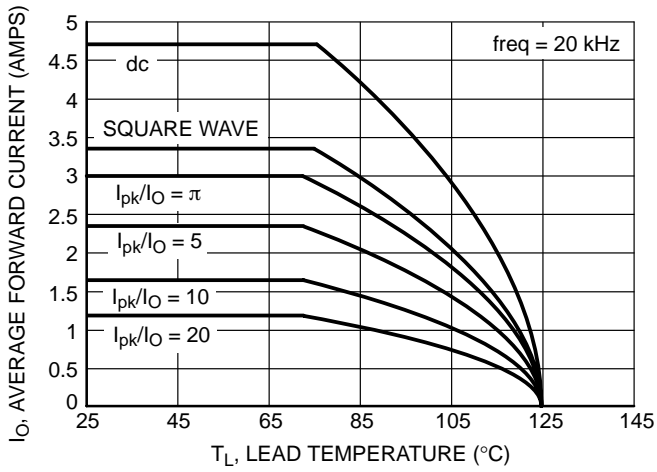


Figure 5. Current Derating

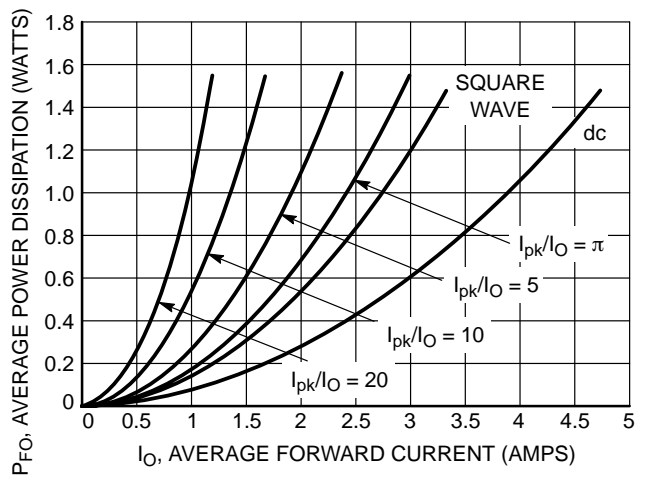


Figure 6. Forward Power Dissipation

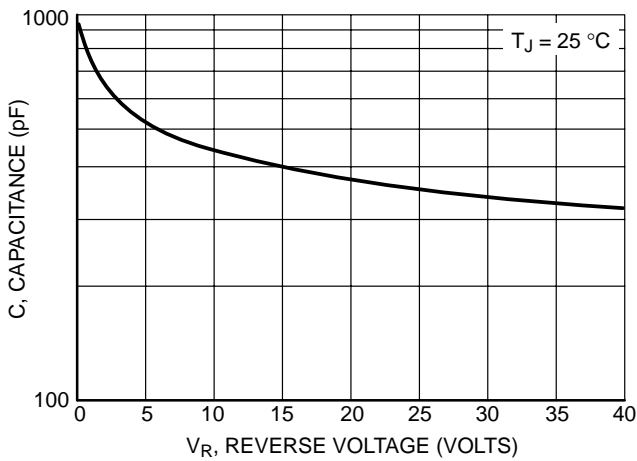


Figure 7. Capacitance

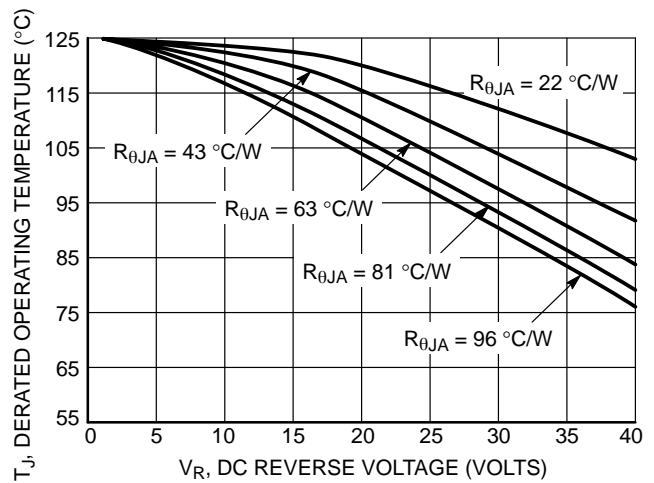


Figure 8. Typical Operating Temperature Derating

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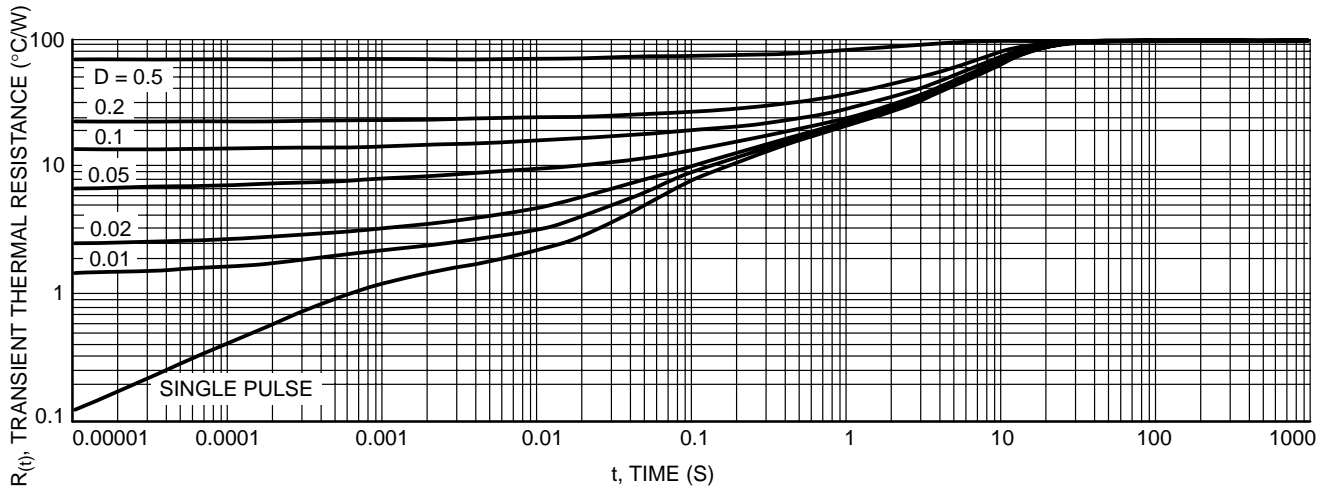


Figure 9. Thermal Response, Junction-to-Ambient (min pad)

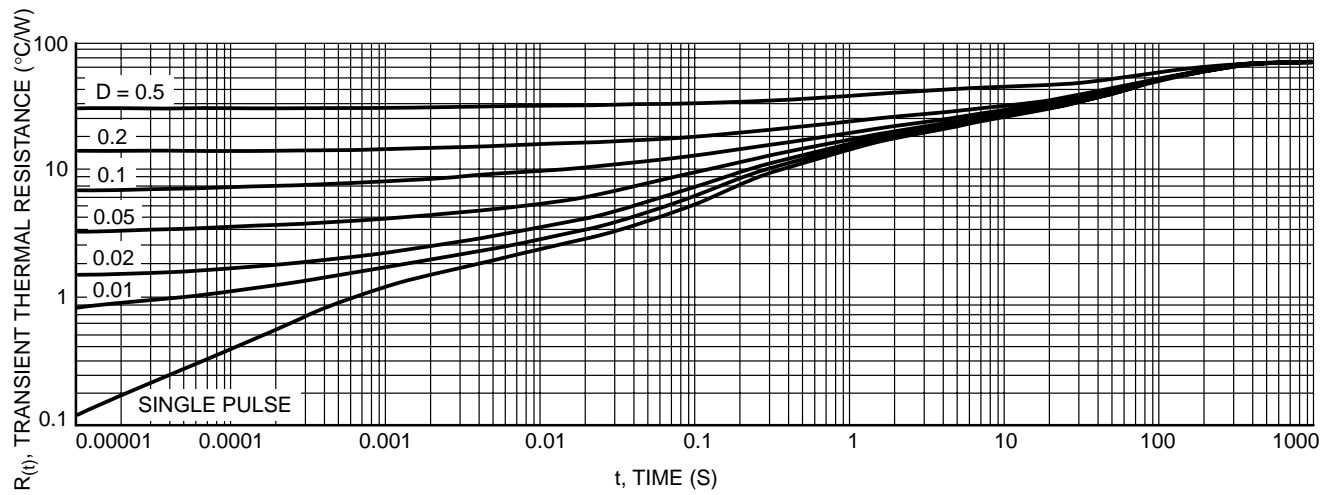
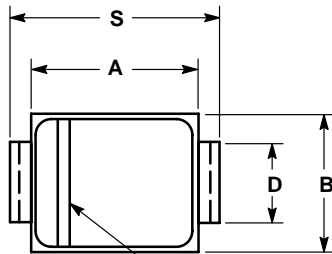


Figure 10. Thermal Response, Junction to Ambient (1 inch pad)

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PACKAGE DIMENSIONS

SMA
CASE 403D-02
ISSUE A

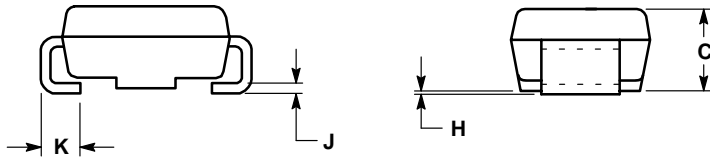


**POLARITY INDICATOR OPTIONAL
AS NEEDED**

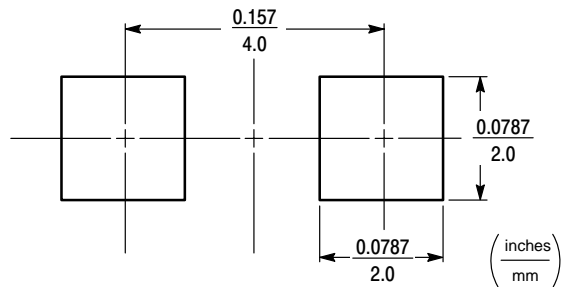
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 403D-01 OBSOLETE, NEW STANDARD IS 403D-02.

| DIM | INCHES | | MILLIMETERS | |
|-----|--------|-------|-------------|------|
| | MIN | MAX | MIN | MAX |
| A | 0.160 | 0.180 | 4.06 | 4.57 |
| B | 0.090 | 0.115 | 2.29 | 2.92 |
| C | 0.075 | 0.095 | 1.91 | 2.41 |
| D | 0.050 | 0.064 | 1.27 | 1.63 |
| H | 0.002 | 0.006 | 0.05 | 0.15 |
| J | 0.006 | 0.016 | 0.15 | 0.41 |
| K | 0.030 | 0.060 | 0.76 | 1.52 |
| S | 0.190 | 0.220 | 4.83 | 5.59 |




SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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